

# BUL310FP

## HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STMicroelectronics PREFERRED SALESTYPE
- NPN TRANSISTOR
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERIZED AT 125°C
- LARGE RBSOA
- FULLY MOLDED INSULATED PACKAGE
- 2000 V DC INSULATION (U.L. COMPLIANT)

#### **APPLICATIONS**

- HORIZONTAL DEFLECTION FOR COLOUR TV
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS

#### DESCRIPTION

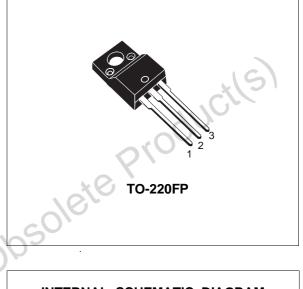
The BUL310FP is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

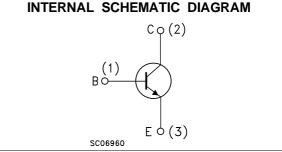
The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.

Symbol	Parameter	Value	Unit	
VCES	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	1000	V	
V <sub>CEO</sub>	Collector-Emitter Voltage $(I_B = 0)$	500	V	
V <sub>EBO</sub>	Emitter-Base Voltage $(I_C = 0)$	9	V	
Ι <sub>C</sub>	Collector Current	5	А	
Ісм	Collector Peak Current (t <sub>p</sub> <5 ms)	10	А	
IB	Base Current	3	А	
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> <5 ms)	4	А	
Ptot	Total Dissipation at Tc = 25 °C	36	W	
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C	
Tj	Max. Operating Junction Temperature	150	°C	

ABSOLUTE MAXIMUM RATINGS

April 2003





### THERMAL DATA

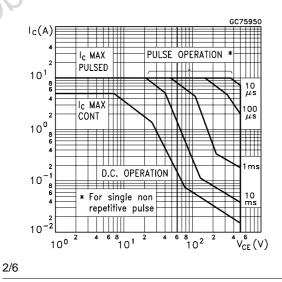
R <sub>thj-case</sub>	Thermal Resistance Junction-Case	Max	3.5	°C/W
R <sub>thj-amb</sub>	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

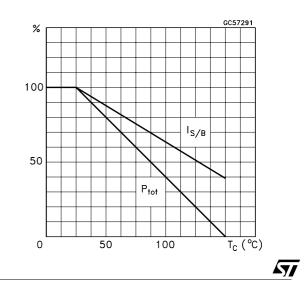
Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V <sub>BE</sub> = 0)	$V_{CE} = 1000 V$ $V_{CE} = 1000 V$ $T_j = 125 \ ^{o}C$			100 500	μΑ μΑ
ICEO	Collector Cut-off Current ( $I_B = 0$ )	V <sub>CE</sub> = 500 V			250	μA
$V_{CEO(sus)^*}$	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 100 mA L= 25 mH	500		d	SY
Vebo	Emitter-Base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 mA	9	-91	<u>,</u>	V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage		Pr	C	0.5 0.7 1.1	V V V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage		,		1 1.1 1.2	V V V
h <sub>FE</sub> *	DC Current Gain		10 6	10	14	
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time			1.2 80	1.9 160	μs ns
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time			1.8 150		μs ns

\* Pulsed: Pulse duration =  $300 \,\mu$ s, duty cycle 1.5 %

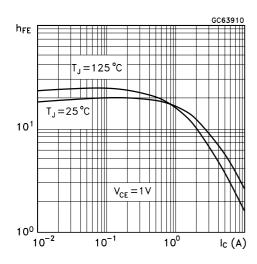
### Safe Operating Areas



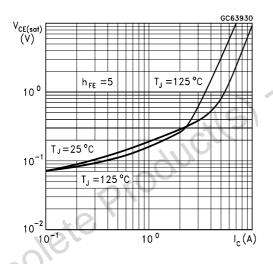
**Derating Curve** 



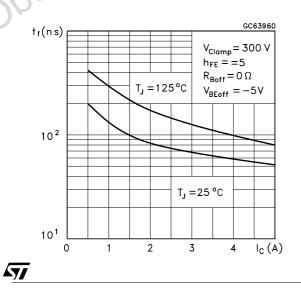
#### DC Current Gain



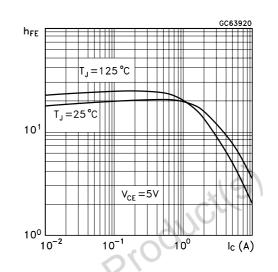
Collector Emitter Saturation Voltage



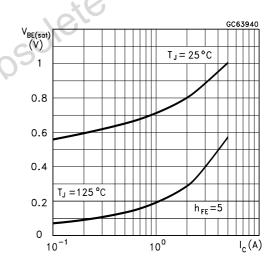
Inductive Load Fall Time

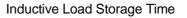


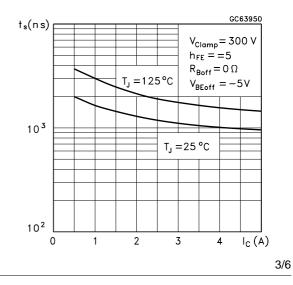
DC Current Gain



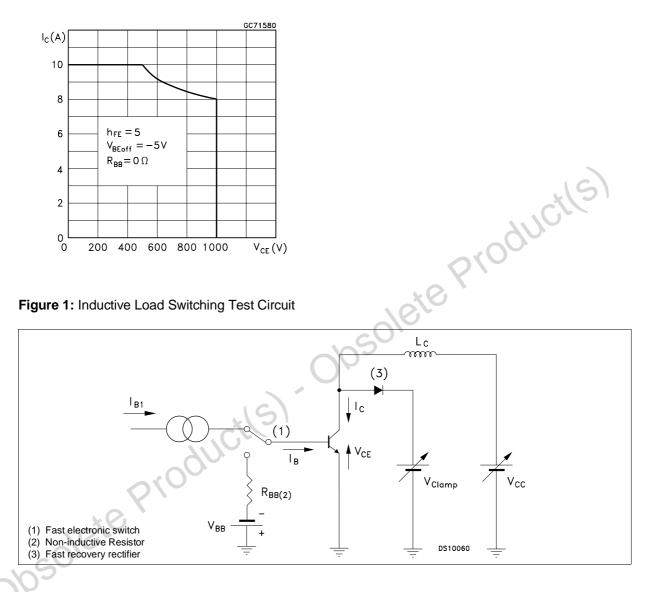
Base Emitter Saturation Voltage







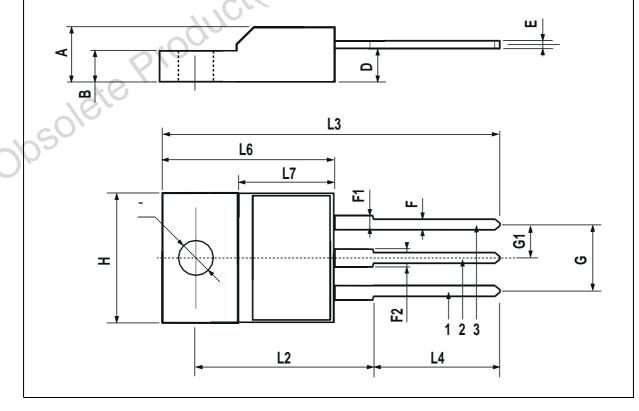
**Reverse Biased SOA** 



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DIM.	mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195	90	0.204
G1	2.4		2.7	0.094	3	0.106
Н	10		10.4	0.393		0.409
L2		16		XO	0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3	IC	3.2	0.118		0.126





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